



## Pool devices and compose bare-metal resources on-demand through automation

Liquid delivers improved resource management and utilization with software-defined composable infrastructure for GPUs, FPGAs, SSDs, NICs and Intel Optane technologies. Resources are unlocked from traditional static configurations and disaggregated into pools of composable resources via high-performance expansion chassis. These resources are then allocated through Liquid Command Center software at bare metal across ultra-low-latency switching fabrics. Liquid is simplifying scalability and resource orchestration across all major data center fabrics, including PCI-Express, Ethernet, and Infiniband.

Liquid enables the pooling and disaggregation of multiple device types, expanding the availability of these resources across the data center through software-defined composability. Create balanced data center systems and recognize increased resource utilization without increasing the data center footprint utilizing composable solutions from Liquid.

The LQD300x04X is a high-performance expansion chassis for the disaggregating and pooling of multiple device types including GPU, FPGA, and SSD AIC. The chassis offers 4x Double Wide PCIe Gen3x16 expansion slots in a 2RU form factor with integrated power and cooling. The chassis offers up to 64GB/s of connectivity to the Liquid Grid Fabric Switch and is optimized for bare metal resources orchestration.

### Key Features

- Interface: PCIe Gen3 or 100GbE
- 4x FHFL Double Wide
- Port Bandwidth: Up to 32 GB/s
- Total Bandwidth: Up to 64 GB/s
- Port Latency: 150 ns
- Power: Up to 1600W (1+1)
- Management: BMC with Fan Mgt.
- Form Factor: 2RU

### Supported Device Types





# LIQID

## LQD300x04X Expansion Chassis

PCIe or Ethernet Connected JBox (GPU/FPGA/SSD/AIC)

### Specification

### Model: LQD300x04X Expansion Chassis

### Selection Options for LQD300x04X

Product	PCIe: LQD300x04P Ethernet: LQD300x04E
Overview	Expansion Chassis for PCIe Devices
Form Factor	2RU
Devices Per Chassis	4x Gen3x16 FHFL Double Wide Devices
Device Type Supported	GPU, FPGA, or SSD AIC (Add-In-Card)
Device Interface	PCIe Gen3x16 per Device
Chassis Cable	PCIe: MiniSAS HD (LQD300x04P) Ethernet: QSFP/QSFP+ (LQD300x04E)
Chassis Interface Ports	PCIe: Up to 2x Gen3x16 Ethernet: Up to 4x Ports 100GbE
Chassis Port Bandwidth	Up to 32 GB/s – Full Duplex
Chassis Total Bandwidth	Up to 64 GB/s – Full Duplex
Fabric Latency	150 ns (PCIe)
Protocol	Software Managed Switching Fabric
Architecture	Disaggregated Bare-metal Infrastructure
Management Software	Liquid Command Center
Environmental Temperature	10°C – 35°C
Power	Up to 1600W (1+1)
Input Voltage	110–240V
Safety Certifications	FCC, UL, CE, CCC, CU
Mgt. Processor	ARM Management Chip
Integrated I/O port	2xRJ45/2xUSB Ports
Dimensions	17.1in x 3.4in x 29.5in

**LQD300x04P - PCIe Connected Expansion Chassis**  
4x GPU/FPGA/SSD/AIC

**LQD300x04E - Ethernet Connected Expansion Chassis**  
4x GPU/SSD

Please contact your sales rep for more information and to determine which configuration is best for use. Specification subject to change without notice.

### Contact Information

Liquid, Inc.  
329 Interlocken Pkwy., Ste 200  
Broomfield, CO 80021  
office: +1 303.500.1551  
email: sales@liquid.com



## About Liquid

A leader in composable infrastructure, Liquid enables users to configure and manage physical, bare-metal server systems in seconds. Storage, compute, networking and graphics processing devices are interconnected over PCI-Express fabric to deliver dynamically configurable bare-metal servers perfectly sized with the exact physical resources required by the application being deployed.